# EE 433 – Fall 2008 Laboratory 2, part 1 Simulation of Passive Components

#### Introduction to the ADS design Software

### **Objectives**:

- To introduce the design tool ADS to the student.
- *To examine the electrical response of real components (with parasitics)*
- To promote an understanding of the usefulness of microwave simulation.
- To foreshadow an impedance matching technique

#### **Background/Introduction**:

Most of your lab time will be learning the ADS design tool. I recommend you go through the introductory tutorial before beginning. It is often easier to find an existing project that is similar to what you what to model, then save it as a new project you can than modify.



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Panasonic		Multilayer Ceramic Capacitors(For General)			
Multilayer Ceramic Chip Capacitors (For General Electronic Equipment)				: :	
Series: ECJ			11		
<ul> <li>Features</li> <li>Small size and wide capacitance range</li> <li>Superior humidity characteristics and long to the monolithic construction</li> <li>Excellent solderability and resistance to heat due to terminals with three layers of nickel and solder</li> <li>Low self-inductance and excellent frequen characteristics</li> </ul>	■ Recommended Applications Class 1 (T.C. Type) Temperature compensations, tuned circuits and filter circuits, where low loss and high stability of capacitance and high insulation resistance are required Class 2 (HI-K Type) Coupling and By-pass, where low loss and high stability of capacitance are not so important				
Explanation of Part Numbers ECJ Series 1 2 3 4 5 E C J 2 (Product Code @Size Code Char (Char	6 7 C 1 © Rated inceristics	8 9 H 1 Voltage	10 11 0 1 minal Capacitance	12 (Ex (Capacitance Tolerance	ample)
Product Code ECJ : Multilayer Ceramic Chip Capacitors		Handling F	recautions		
Construction					
	No	Name			
	1	Ceramic dielectric			
₩°~AK°	2	Inner electrode			
· · · · · · · · · · · · · · · · · · ·	3	Substrate electrode			
$\bigcirc$	4	Intermediate electrode			
	(5)	External electrode			
Dimensions in mm (not to scale)					Unit : mr
Code	Size Code (EIA)	L	w	Т	L1, L2
Z	"06" Type 0201	0.60±0.03	0.30±0.03	0.30±0.03	0.15±0.05
0	*10" Type 0402	1.00±0.05	0.50±0.05	0.50±0.05	0.2±0.1
	0603	1.6±0.1	0.8±0.1	0.8±0.1	0.3±0.2
T2	"12" Type 0805	2.0±0.1	1.25±0.10	0.6±0.1 0.85±0.10 1.25±0.10	0.50±0.25
3	"13" Type 1206	3.20±0.15	1.60±0.15	0.6±0.1 0.85±0.10 1.15±0.10 1.6±0.2	0.6±0.3
4	"23" Type 1210	3.2±0.3	2.5±0.2	2.0±0.2	0.6±0.3
Design and specifications are subject to change Whenever a doubt about safety arises tr	without notice. Ask om this product, ple	factory for technical asse contact us imm	specifications be rediately for techn	fore purchase and Ical consultation.	/or use.

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## **Laboratory Procedures**

- (1) Derive a model for the 10 nH 0805 inductor
- (2) Derive a model for the 10 pF capacitor
- (3) Setup an ADS project and your models as one ports
- (4) Plot the impedance curve of the capacitor and see how close it comes to the above plot. Adjust your model for the best fit. Use a frequency span of 1 MHz to 10 GHz.
- (5) What value of "ideal" capacitor would you use for the impedance of the "real" capacitor at 800 MHz? This is called the capacitance multiplication effect.
- (6) Plot the real inductor and an ideal 10 nH inductor on the smith chart. Explain what you are seeing.
- (7) Plot the real capacitor and an ideal capacitor on the smith chart. Explain what you are seeing.
- (8) Create a new circuit consisting of your real capacitor model in series with a Tline of Zo=50 ohms, L= 90degrees at 1 GHz. Plot the impedance curve as you did in part 2.

#### **Data Analysis and Reporting**

Write a summary report as you did for the first lab.